SKD 33



Power Bridge Rectifiers

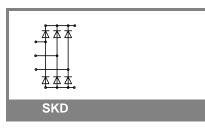
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Features

- Glass passivated silicon chips
- Low thermal impedance through use of direct copper bonded aluminum substrate (DCB) base plate
- Blocking voltage up to 1800 V
- Suitable for PCB mounting and wave soldering
- For applications with high vibrations we recommend to fasten the bridge to the pcb with 4 selftapping screw

Typical Applications

- Three phase rectifiers for power supplies
- Input rectifiers for variable frequency drives
- Rectifiers for DC motor field supplies
- Battery charger rectifiers
- 1) Freely suspended or mounted on an insulator
- Mounted on a painted metal sheet of min.
 250 x 250 x 1 mm
- 3) T_{solder} = 250 ± 10 °C (10 s)

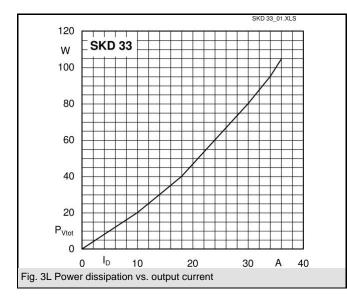


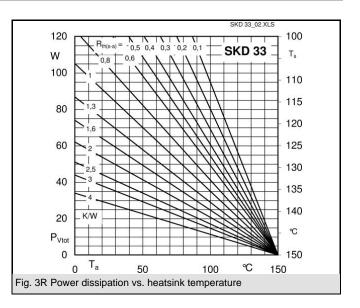
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V _{RSM}	V _{RRM} , V _{DRM}	I _D = 33 A (full conduction)
V	V	(T _s = 110 °C)
500	400	SKD 33/04
900	800	SKD 33/08
1300	1200	SKD 33/12
1700	1600	SKD 33/16
1900	1800	SKD 33/18

Symbol	Conditions	Values	Units
I _D	T _s = 106 °C	36	А
5	$T_a = 45 \text{ °C}; \text{ isolated } ^{1)}$	4	А
	$T_a = 45 \text{ °C}; \text{ chassis }^{2)}$	16	А
	T _a = 45 °C; P5A/100 (R4A/120)	24 (25)	А
	T _a = 35 °C; P1A/120F	50	А
I _{FSM}	T _{vi} = 25 °C; 10 ms	300	Α
	T _{vi} = 150 °C; 10 ms	240	А
	T _{vi} = 25 °C; 8,3 10 ms	450	A²s
	T _{vj} = 150 °C; 8,3 10 ms	290	A²s
V _F	T _{vi} = 25 °C; I _F = 50 A	max. 1,6	V
V _(TO)	T _{vi} = 150 °C	max. 0,8	V
r _T	T _{vi} = 150 °C	max. 18	mΩ
I _{RD}	$T_{vi} = 25 \text{ °C}; V_{DD} = V_{DRM}; V_{RD} = V_{RRM}$	max. 0,2	mA
	$T_{vj} = 150 \text{ °C}; V_{RD} = V_{RRM}$	4	mA
R _{th(j-s)}	per diode	2.5	K/W
th(j-s)	total	0,417	K/W
R _{th(j-a)}	isolated ¹⁾	15,02	K/W
ung-a)	chassis ²⁾	3,02	K/W
T _{vj}		- 40 + 150	°C
T _{stg}		- 40 + 125 ³⁾	°C
V _{isol}	a. c. 50 Hz; r.m.s.; 1 s / 1 min.	3600 (3000)	V
Ms	to heatsink	2 ± 15 %	Nm
M,			
a		5 * 9,81	m/s²
m		30	g
Case		G 55	

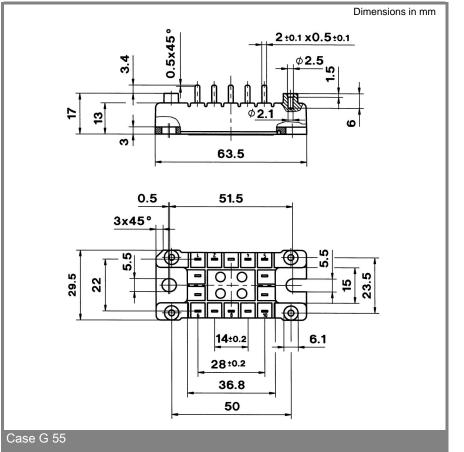
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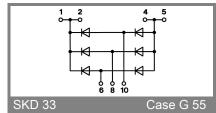
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